TinyLogic UHS Triple Inverter with Schmitt Trigger Input

NC7NZ14

Description

The NC7NZ14 is a triple inverter with Schmitt trigger input from **onsemi**'s Ultra−High Speed (UHS) series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra−high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65 V to 5.5 V V_{CC} range. The inputs and outputs are high−impedance when V_{CC} is 0 V. Inputs tolerate voltages up to 5.5 V independent of V_{CC} operating voltage.

Features

- Ultra High−Speed: t_{PD} = 3.7 ns (Typical) into 50 pF at 5 V V_{CC}
- High Output Drive: ±24 mA at 3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.5 V
- Power Down High Impedance Inputs / Outputs
- Over−Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra−Small MicroPak™ Packages
- Space−Saving US8 Surface Mount Package
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

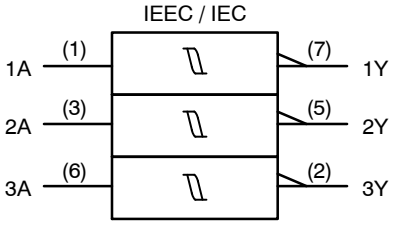


Figure 1. Logic Symbol

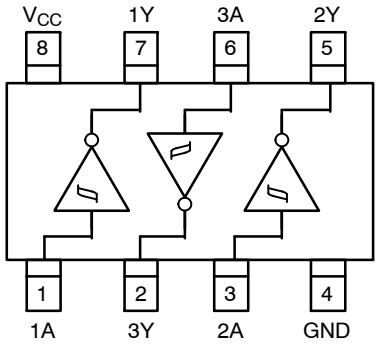
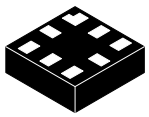


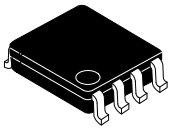
Figure 2. Connection Diagram (Top View)

MARKING DIAGRAMS

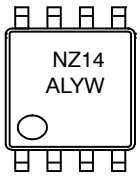


UQFN8
1.6X1.6, 0.5P
CASE 523AY





US8
CASE 846AN



P6, NZ14	= Specific Device Code
KK	= 2−Digit Lot Run Traceability Code
XY	= 2−Digit Date Code Format
Z	= Assembly Plant Code
A	= Assembly Site
L	= Wafer Lot Number
YW	= Assembly Start Week

ORDERING INFORMATION

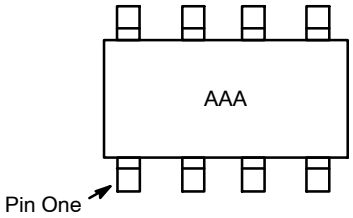
See detailed ordering, marking and shipping information on page 6 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

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Pin Configurations



NOTES:
1. AAA represents product code top mark (see ordering table).
2. Orientation of top mark determines pin one location. Reading the top product code mark left to right, pin one is the lower left pin.

Figure 3. US8

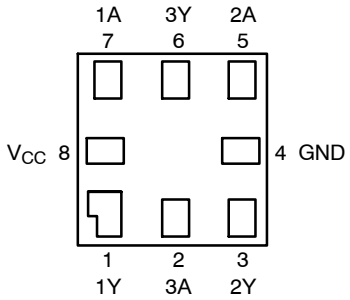


Figure 4. MicroPak (Top Through View)

PIN DEFINITIONS

Pin # US8	Pin # MicroPak	Name	Description
1	7	1A	Input
2	6	3Y	Output
3	5	2A	Input
4	4	GND	Ground
5	3	2Y	Output
6	2	3A	Input
7	1	1Y	Output
8	8	V_{CC}	Supply Voltage

FUNCTION TABLE

Input	Output
A	**Y**
L	H
H	L

H = HIGH Logic Level
L = LOW Logic Level

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ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min	Max	Unit
V_{CC}	Supply Voltage		−0.5	6.5	V
V_{IN}	DC Input Voltage		−0.5	6.5	V
V_{OUT}	DC Output Voltage		−0.5	6.5	V
I_{IK}	DC Input Diode Current	V_{IN} < 0 V	−	−50	mA
I_{OK}	DC Output Diode Current	V_{OUT} < 0 V	−	−50	mA
I_{OUT}	DC Output Current		−	±50	mA
I_{CC} / I_{GND}	DC V_{CC} or Ground Current		−	±50	mA
T_{STG}	Storage Temperature Range		−65	+150	°C
T_J	Junction Temperature Under Bias		−	+150	°C
T_L	Junction Lead Temperature (Soldering, 10 Seconds)		−	+260	°C
P_D	Power Dissipation in Still Air	US8	−	500	mW
		MicroPak−8	−	539	
ESD	Human Body Model, JEDEC: JESD22−A114		−	4000	V
	Charge Device Model, JEDEC: JESD22−C101		−	2000	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply Voltage Operating		1.65	5.5	V
	Supply Voltage Data Retention		1.5	5.5	
V_{IN}	Input Voltage		0	5.5	V
V_{OUT}	Output Voltage		0	V_{CC}	V
T_A	Operating Temperature		−40	+85	°C
θ_{JA}	Thermal Resistance	US8	−	250	°C/W
		MicroPak−8	−	232	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. Unused inputs must be held HIGH or LOW. They may not float.

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DC ELECTICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	T_A = +25°C			T_A = −40 to +85°C		Unit
				Min	Typ	Max	Min	Max	
V_P	Positive Threshold Voltage	1.65		–	1.10	1.50	–	1.50	V
		2.30		–	1.40	1.80	–	1.80	
		3.00		–	1.75	2.20	–	2.20	
		4.50		–	2.45	3.10	–	3.10	
		5.50		–	2.90	3.60	–	3.60	
V_N	Negative Threshold Voltage	1.65		0.25	0.55	–	0.25	–	V
		2.30		0.40	0.75	–	0.40	–	
		3.00		0.60	1.00	–	0.60	–	
		4.50		1.00	1.43	–	1.00	–	
		5.50		1.20	1.70	–	1.20	–	
V_H	Hysteresis Voltage	1.65		0.15	0.54	1.00	0.15	1.00	V
		2.30		0.25	0.65	1.10	0.25	1.10	
		3.00		0.40	0.77	1.20	0.40	1.20	
		4.50		0.60	1.01	1.50	0.60	1.50	
		5.50		0.70	1.18	1.70	0.70	1.70	
V_{OH}	HIGH Level Output Voltage	1.65	$V_{IN} = V_P$ or V_N, I_{OH} = −100 μA	1.55	1.65	–	1.55	–	V
		2.30		2.20	2.30	–	2.20	–	
		3.00		2.90	3.00	–	2.90	–	
		4.50		4.40	4.50	–	4.4	–	
		1.65	I_{OH} = −4 mA	1.29	1.52	–	1.29	–	
		2.30	I_{OH} = −8 mA	1.90	2.15	–	1.90	–	
		3.00	I_{OH} = −16 mA	2.40	2.80	–	2.40	–	
		3.00	I_{OH} = −24 mA	2.30	2.68	–	2.30	–	
		4.50	I_{OH} = −32 mA	3.80	4.20	–	3.80	–	
V_{OL}	LOW Level Output Voltage	1.65	$V_{IN} = V_P$ or V_N, I_{OL} = 100 μA	–	0.00	0.10	–	0.10	V
		2.30		–	0.00	0.10	–	0.10	
		3.00		–	0.00	0.10	–	0.10	
		4.50		–	0.00	0.10	–	0.10	
		1.65	I_{OL} = 4 mA	–	0.08	0.24	–	0.24	
		2.30	I_{OL} = 8 mA	–	0.10	0.30	–	0.30	
		3.00	I_{OL} = 16 mA	–	0.15	0.40	–	0.40	
		3.00	I_{OL} = 24 mA	–	0.22	0.55	–	0.55	
		4.50	I_{OL} = 32 mA	–	0.22	0.55	–	0.55	
I_{IN}	Input Leakage Current	1.65 to 5.5	V_{IN} = 5.5 V, GND	–	–	±0.1	–	±1.0	μA
I_{OFF}	Power Off Leakage Current	0	V_{IN} or V_{OUT} = 5.5 V	–	–	1	–	10	μA
I_{CC}	Quiescent Supply Current	1.65 to 5.50	V_{IN} = 5.5 V, GND	–	–	1.0	–	10	μA

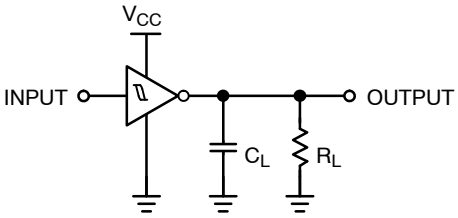
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AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	T_A = +25°C			T_A = −40 to +85°C		Unit
				Min	Typ	Max	Min	Max	
t_{PLH}, t_{PHL}	Propagation Delay (Figure 5, 6)	1.80 ±0.15	C_L = 15 pF, R_L = 1 MΩ,	–	7.6	12.5	–	13.0	ns
		2.50 ±0.20		–	5.0	9.0	–	9.5	
		3.30 ±0.30		–	3.7	6.3	–	6.5	
		5.00 ±0.50		–	3.1	5.2	–	5.5	
		3.30 ±0.30	C_L = 50 pF, R_L = 500 Ω,	–	4.4	7.2	–	7.5	
		5.00 ±0.50		–	3.7	5.9	–	6.2	
C_{IN}	Input Capacitance	0.00		–	2.5	–	–	–	pF
C_{PD}	Power Dissipation Capacitance (Note 4) (Figure 7)	3.30		–	9	–	–	–	pF
		5.00		–	11	–	–	–	

4. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})\ (V_{CC})\ (f_{IN}) + (I_{CC}static)$.



NOTE:
5. C_L includes load and stray capacitance; Input PRR = 1.0 MHz, t_W = 500 ns.

Figure 5. AC Test Circuit

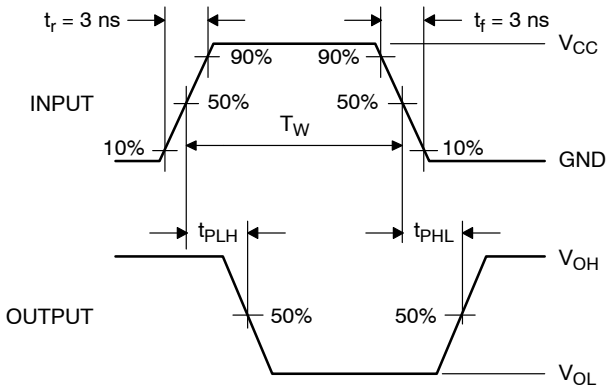
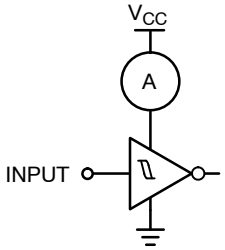


Figure 6. AC Waveforms



NOTE:
6. Input = AC Waveform; t_r = t_f = 1.8 ns; PRR = 10 MHz; Duty Cycle = 50%.

Figure 7. I_{CCD} Test Circuit

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ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping†
NC7NZ14K8X	NZ14	8−Lead US8, JEDEC MO−187, Variation CA 3.1 mm Wide	3000 / Tape & Reel
NC7NZ14L8X	P6	8−Lead MicroPak, 1.6 mm Wide	5000 / Tape & Reel

DISCONTINUED (Note 7)

NC7NZ14L8X−L22185	P6	8−Lead MicroPak, 1.6 mm Wide	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

7. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on www.onsemi.com.

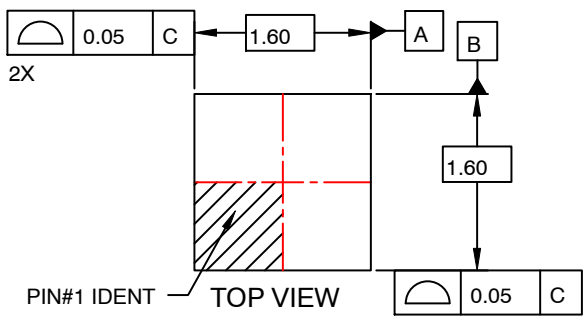
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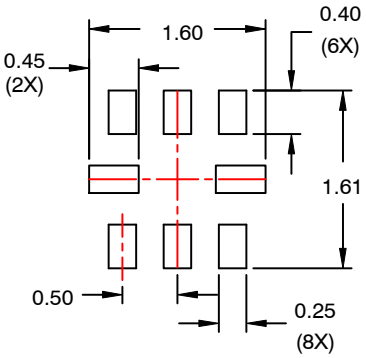
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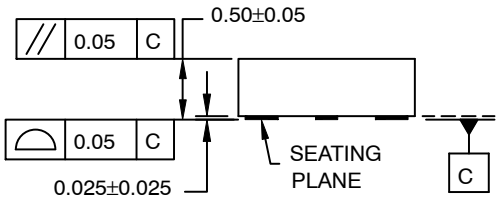
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CASE 523AY
ISSUE O

DATE 31 AUG 2016





RECOMMENDED
LAND PATTERN



SIDE VIEW

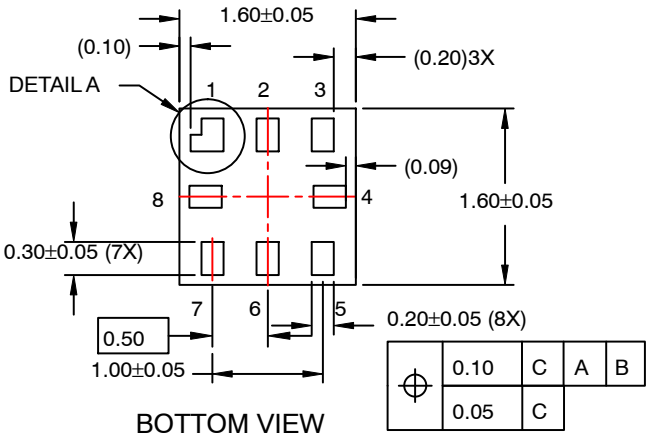
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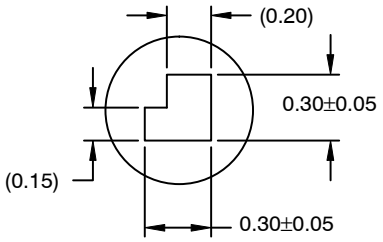
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BOTTOM VIEW



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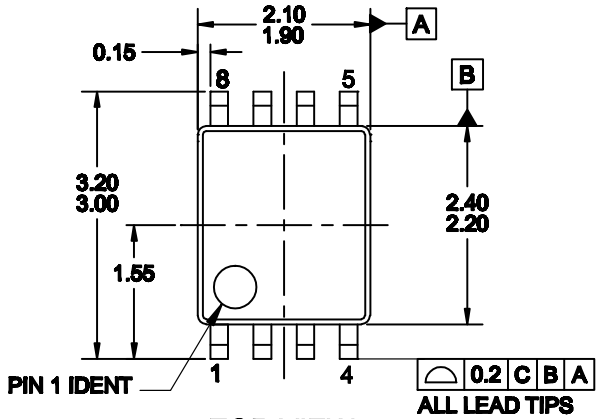
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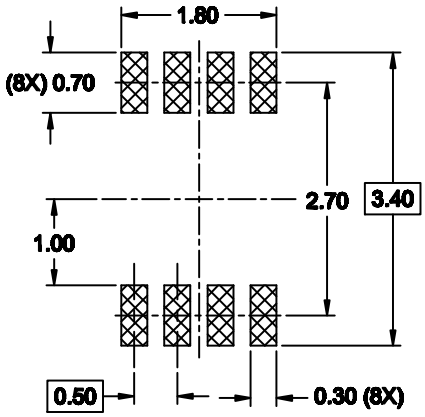
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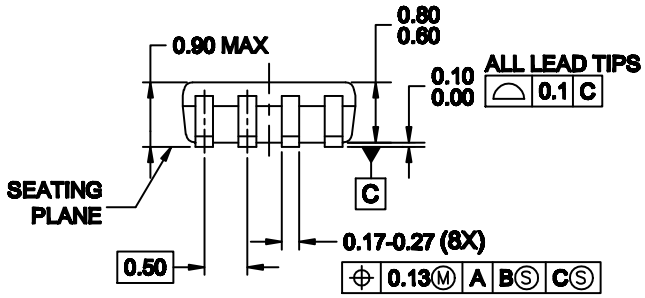
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TOP VIEW



RECOMMENDED LAND PATTERN



SIDE VIEW

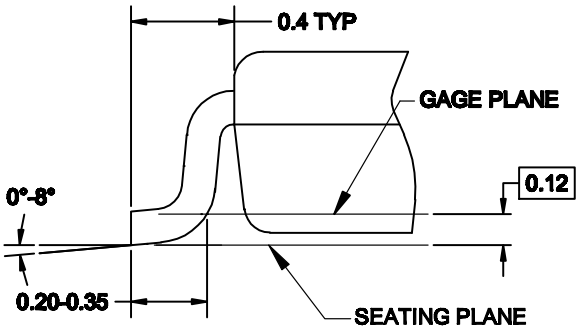
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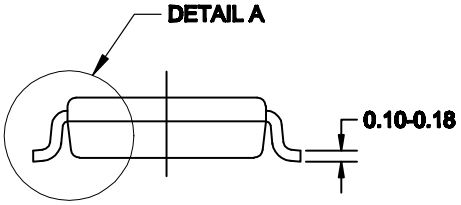
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DETAIL A



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